

# ECOFREC™ TF40



#### No-clean flux paste for rework

#### **PERFORMANCES**

ECOFREC™ TF4O is a tacky flux paste designed for **rework and soldering** of traditional components and SMDs.

ECOFREC™ TF4O is particularly efficient for BGA repairing and the balling of components using balls interconnection.

### **SPECIFICATIONS**

Colour Odour

Solubility

in water

In alcohol

Classification according ANSI/J-STD-004

Acid index (mg KOH /g)

Halogen %

Density at 20°C

Viscosity at 20°C Pa.s

(Measured on BROOKFIELD RVT viscosimeter with

Mobile F HELIPATH system, at 5 rpm).

amber

very low

not soluble

soluble

REL0

**RMA** 

87

1.03

500

#### **CHARACTERISTICS**

ECOFREC™ TF40 is a high viscosity paste made of a complex blending of resins, activators and solvents. After soldering, flux residues remaining on the PCB are non aggressive and not liable to corrosion. PCB cleaning is thus unnecessary.

#### **PACKAGING TYPE**

Syringe Plastic drum Cartridge

10 g or 30 g 100 g

300 g

### STORAGE AND SHELF LIFE

Flux €COFR€C™ TF4O must be stored in a cool and ventilated area between 5° and 30°C. Shelf life is about one year long.

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#### **CONDITIONS OF USE**

ECOFREC™ TF4O can be applied by dispensing or screen/stencil printing.

The sticky properties of Flux €COFR€C<sup>™</sup> TF4O ensure that components are kept in position until the alloy is reflowed. A variety of heating methods may be used to produce the solderjoint with €COFR€C<sup>™</sup> TF4O; these include soldering irons, hot gas and hot bar devices, IR or convection oven or vapour phase.

Printing adhesive properties can be improved after 30-60 minutes storage or after heating at 50-60°C during few minutes.

#### **HSE**

During soldering operations, evolving vapours should be collected by an efficient exhaust system.

Please refer to MSDS before use.

Although the conformity to ROHS 2002/95CE concerns EQUIPMENT put on the market and not a component in particular, we warranty that this product contains less than 0.1% of mercury, lead, chromium VI, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE) and less than 0.01% for the cadmium, in accordance with the decision of the European Commission dated 18/08/2005, fixing the maximal concentration values.

This data is based on information that the manufacturer believe to be reliable and offered in good faith. In no event will AVANTEC be responsible for special, incidental and consequential damages. The user is responsible to the Administrative Authorities (regulations for the protection of the Environment) for the conformity of his installation.

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